Investigation of the Electrical Characteristics of the Metal/Organic Semiconductor/Metal Structures with Top Contact Configuration

Šarūnas MEŠKINIS¹, Kęstutis ŠLAPIKAS¹, Rimas GUDAITIS¹, Sigitas TAMULEVIČIUS¹, Aleksandras ILJINAS¹, Angelė GUDONYTĖ¹, Juozas Vidas GRAŽULEVIČIUS², Vytautas GETAUTIS², Asta MICHALEVIČIUTĖ², Tadas MALINAUSKAS², Ramūnas LYGAITIS²

¹Institute of Materials Science of Kaunas University of Technology, Savanorių 271, LT-50131 Kaunas, Lithuania
²Faculty of Chemical Technology, Kaunas University of Technology, Radvilėnų 19, LT-50254 Kaunas, Lithuania

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In present study four newly synthesized organic semiconductor compounds have been used for fabrication of the planar metal/organic semiconductor/metal structures. I-V characteristics of the samples were investigated. Effect of the hysteresis of the I-V characteristics was observed for all samples investigated. However, strength of the hysteresis depended on organic semiconductor used. Charge transfer mechanisms were considered. In all cases the main charge transfer mechanism was trap activated tunneling. Yet at higher electric fields Schottky emission should be considered as well.

Keywords: organic semiconductor, metal-semiconductor contacts, spin coating, current-voltage characteristics, charge transport mechanisms.

1. INTRODUCTION

Organic semiconductors are at the top of the considerable interest due to the possibility to make electronic devices on flexible materials (for example plastic or paper) using cheap technological processes such as spin coating and printing [1–4]. In order to improve efficiency of an organic semiconductor device, it is important to have a comprehensive knowledge of charge transport mechanism, because it is one of the main factors affecting the device characteristics. Particularly electrical properties of the metal/organic semiconductor contacts are under intensive investigations, because understanding of the basic transport mechanisms in these junctions is very helpful in distinguishing between the influence of the interfacial and bulk effects on electrical properties of the organic semiconductor based devices. Such information would help to select the most problematic parts of the organic semiconductor devices and ways for optimization of the device fabrication technology. In such a way improvement of the functional characteristics of the organic semiconductor based electronic devices such as organic field effect transistors (OFET), organic solar cells, organic light emitting diodes would be achieved.

In present research, current-voltage (I-V) characteristics of the metal/organic semiconductor/metal structures fabricated using the four new organic semiconducting compounds were investigated. Charge transport mechanisms in metal/organic semiconductor/metal structures were studied.

2. EXPERIMENTAL

In the present study top-contact configuration of the samples has been used (Fig. 1). Monocrystalline wafers with thermally grown silicon dioxide (SiO₂) layers on the top were used as a readily available substrates. Before deposition of the organic semiconductor layer the substrates were degreased in dimethylformamide and acetone. Afterwards organic semiconductor thin films were deposited by spin coating (deposition conditions are presented in Table 1).

Formation of the samples was finished by vacuum evaporation of the metal electrodes. 300 nm thickness Al, Au, Cr and Ti films were deposited through the mask. In most experiments square-shaped electrodes were applied (Fig. 1).

Four organic semiconductors were investigated in the present study:

• 4,4’-diformyltriphenylamine bis(N-2,3-epoxypropyl-N-phenylhydrazone) (further in the present study MT-12);
• Di(2,2-diphenylvinyl)(9-ethyl-3-carbazolyl)amine (further in the present study E-139);

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bulb limited (space charge limited current, Poole-Frenkel emission) mechanisms were investigated.

Schottky emission (current flow over the potential barrier at the metal/semiconductor contact) is described by the following equation [8]:

\[ J = A^* T^* \exp \left( \frac{\beta_0 E_1^{1/2} - q \phi_B}{kT} \right), \] (1)

where \( J \) is the current density, \( \beta_0 = (q^3/4\pi\varepsilon_0\varepsilon)^{1/2} \), \( A^* \) – effective Richardson constant, \( q \) – electron charge, \( \varepsilon_0 \) – vacuum dielectric permittivity, \( k \) – Boltzmann constant, \( T \) – temperature, \( \phi_B \) – Schottky contact potential barrier height, \( \varepsilon \) – organic semiconductor dielectric permittivity. Thus presence of the Schottky emission can be identified from the linear dependence of \( \ln(J) \sim E^{1/2} \). Presence of that charge transfer mechanism can be checked by comparison of the dielectric permittivity calculated from the (1) equation with dielectric permittivity calculated from the capacitance-voltage measurement data, too.

Fowler-Nordheim tunnelling is described by the following equation: [8]

\[ J = \frac{m^* q}{8\pi^2 h \phi} \exp \left( -\frac{B}{E} \right), \] (2)

where \( m^* \) is the electron mass, \( m^* \) – electron effective mass, \( h \) – Planck constant, \( \phi \) – potential barrier height. Presence of the Fowler-Nordheim charge transfer mechanism can be identified from the linear dependence of \( \ln(J/E^2) \sim E^{1/2} \).

Trap assisted tunnelling via traps at the metal/organic semiconductor interface is described by \( \ln(J) \sim 1/E \) dependence [9].

Space charge limited current is related with accumulation of the space charge in bulk of the semiconductor [8]. It can be described by the \( \log(J) \sim \log V \) (\( \log(J) \sim \log(E) \)) dependence. In such a case current density is dependent on the distance between the electrodes: the higher distance the lower current density will be detected.

Poole-Frenkel emission is related to trapping of the charge carriers by local traps related with bulk defects and subsequent release of the trapped charge carriers from these potential wells [8]. Poole-Frenkel emission can be described by following equation:

\[ J = J_0 \exp \left( \frac{\beta_{PF} E_1^{1/2} - q \phi_{PF}}{kT} \right), \] (3)

where \( \beta_{PF} = (q^3/4\pi\varepsilon_0\varepsilon)^{1/2} \). The Poole-Frenkel emission can be identified by known dependence of the relation \( \ln(J/E^2) \sim E^{1/2} \). Presence of that charge transfer mechanism can be checked by comparison of the dielectric permittivity calculated from the equation (4) with the dielectric permittivity calculated from the capacitance-voltage measurement data, too.

3. EXPERIMENTAL RESULTS

3.1. Peculiarities of the current-voltage characteristics and I-V hysteresis effects

Typical current-voltage characteristics of the metal/organic semiconductor (AT-RB-1) contacts are presented in Fig. 3. In all cases no clear relation between the electrode metal workfunction (Table 2) and I-V

**Table 1. Parameters of the organic semiconductor thin film deposition process**

<table>
<thead>
<tr>
<th>Organic semicond.</th>
<th>Solvent</th>
<th>Solution formation temp.</th>
<th>Concentr. of the solution (%)</th>
<th>Spin coat. rate (rpm)</th>
<th>Thickness of the layer (nm)</th>
</tr>
</thead>
<tbody>
<tr>
<td>AT-RB-1</td>
<td>THF*</td>
<td>Room</td>
<td>5</td>
<td>6000</td>
<td>178</td>
</tr>
<tr>
<td>AT-RB-2</td>
<td>THF*</td>
<td>Room</td>
<td>5</td>
<td>6000</td>
<td>162</td>
</tr>
<tr>
<td>E-139</td>
<td>THF*</td>
<td>Room</td>
<td>3</td>
<td>8000</td>
<td>170</td>
</tr>
<tr>
<td>MT-12</td>
<td>THF*</td>
<td>−40°C</td>
<td>5</td>
<td>6000</td>
<td>168</td>
</tr>
</tbody>
</table>

* THF refers to the tetrahydrofurane.

Different charge transfer mechanisms in metal/organic semiconductor contacts were considered in present research. To define possible charge transfer mechanisms both contact limited (Schottky emission, Fowler-Nordheim emission, trap activated tunnelling) and
Characteristics of the metal/organic semiconductor contacts were observed.

Current-voltage characteristics of all the samples investigated can be divided into two groups. The only exclusion are samples fabricated using organic semiconductor AT-RB-2 (Fig. 4). In this case the large scattering of the measured characteristics was detected.

![Fig. 3. I-V characteristics of the metal/AT-RB-1/metal structure](image)

![Fig. 4. I-V characteristics of the metal/AT-RB-2/metal structure](image)

![Fig. 5. Hysteresis of I-V characteristics of the Al/AT-RB-1/Al structure in ±100 V (a) and ±300 V, ±500 V (b) voltage ranges](image)

Table 2. Work functions of the metals used in present study (according to [10])

<table>
<thead>
<tr>
<th>Metal</th>
<th>Al</th>
<th>Au</th>
<th>Cr</th>
<th>Ti</th>
</tr>
</thead>
<tbody>
<tr>
<td>Work function (eV)</td>
<td>4.06 – 4.26</td>
<td>5.10 – 5.47</td>
<td>4.50</td>
<td>4.33</td>
</tr>
</tbody>
</table>

![Fig. 6. The dependence of the current strength on time at constant voltage for metal/AT-RB-1/metal structure](image)

Effect of the hysteresis of the current-voltage characteristics was observed for all the samples fabricated using organic semiconductors MT-12, AT-RB-1, AT-RB-1 (air annealed) as well as E-139 (Fig. 5). Typical hysteresis of I-V characteristics for Al/AT-RB-1/Al structure is presented in Fig. 5. The hysteresis was more pronounced when “bipolar” measurement of I-V characteristic (beginning from the same voltage ≠ 0 V) was performed instead of the unipolar measurement beginning with 0 V. Hysteresis of the I-V characteristic measured in ±100 V, ±300 V, ±500 V voltage ranges had the same shape, while difference between the currents measured during the “forward” and “back” measurements increased with increase of the voltage range. The difference between the “forward” and “back” current at the point of the maximum measurement voltage (Fig. 5) can be explained by change of the current density at the measurement voltage as it is shown in Fig. 6. It can be seen in Fig. 5, that at 100 V voltage after the 1 min current strength change as high as 3 times for metal/AT-RB-1/metal structure was observed. It should be mentioned, that other authors reported about the I-V characteristic hysteresis effects in the case of the metal-organic semiconductor contacts, too (e.g., [11, 12]).

In the case of the samples fabricated using organic semiconductor AT-RB-2 hysteresis of the I-V characteristics is less pronounced (Fig. 4).

I-V characteristics of the Al/organic semiconductor/Al and Cr/organic semiconductor/Cr samples fabricated using different organic semiconductors are presented in Fig. 7. In all cases I-V characteristics can be divided to the two groups. The smallest differences between I-V characteristics belonging to the different groups can be seen in the case of the MT-12 organic semiconductor. It can be mentioned, that in the case of the samples fabricated using organic semiconductor E-139 higher current were measured in comparison with the samples fabricated using organic semiconductor AT-RB-1. Data on hysteresis of the I-V characteristics in ±200 V range can be seen in Fig. 7, b. The highest currents and the biggest hysteresis of I-V characteristics effect were observed in the case of the metal/organic semiconductor/metal structures fabricated using organic
semiconductor MT-12. It should be mentioned, that in the case of the Al/AT-RB-2/Al samples I-V characteristics were asymmetrical, diode-like (Fig. 7, c). While in the case of Cr/AT-RB-2/Cr structures relatively weak currents were observed and absence of the hysteresis.

Fig. 7. I-V characteristics of metal/organic semiconductor/metal structures fabricated using different organic semiconductors: electrode metal Al (a, c) and Cr (b). In c, d, pictures solid symbols refer to the measurement from –200 V to +200 V and hollow symbols refer to the measurement from +200 V to –200 V.

3.2. Charge transfer mechanisms

In present study charge transfer mechanisms in metal/organic semiconductor/metal structures were studied. Linear and quasi-linear $I \sim U^{1/2}$ dependence ranges can be seen in Schottky plot for Al/organic semiconductor/Al structures (Fig. 8). However, only for highest voltages (electric field strength) dielectric permittivity value calculated from I-V characteristic was 2.3 – 2.7 – the value within the range of the dielectric permittivities reported in literature (according to [13 – 15] 1.5 – 8). In other cases unrealistically low values of the dielectric permittivity ($\varepsilon < 1$) was achieved.

Two tunnelling related charge transfer mechanisms – trap activated tunnelling (TAT) and Fowler-Nordheim emission were considered as well. It can be seen in Fig. 9, that TAT is possible charge transfer mechanism in our case. While there is no areas of the linear dependence $\ln(J/E^2) \sim E^{1/2}$ in Fowler-Nordheim plot (Fig. 10).

Fig. 8. Schottky plot of the I-V characteristics of Al/organic semiconductor/Al sample

Fig. 9. TAT plot of the I-V characteristics of Al/organic semiconductor/Al sample

In the case of the plots related with the bulk limited charge transfer mechanisms linear and quasi-linear areas can be seen in double logarithmic plot (Fig. 11). It is the behaviour typical for space charge limited current. It was mentioned above, that current density should depend on the distance between the electrodes in the case of the space charge limited currents. However, no dependence of the current density on distance between the electrodes was observed (Fig. 11, b). It means, that the space charge limited currents are not between the main charge transfer mechanisms in investigated samples. Poole-Frenkel plot is presented in Fig. 12. Some areas of the linear or quasilinear dependence of the $\ln(J/E^2) \sim E^{1/2}$ can be seen in it. However, dielectric permittivity values of the organic semiconductors calculated from the Poole-Frenkel plot were too low (<1) or unrealistically big (>1500).
In general, the study revealed, that the main charge transfer mechanism in the investigated metal/organic semiconductor/metal samples is trap activated tunnelling. However, at higher voltages (electric field strengths) Schottky emission is possible as well. In such a case absence of the clear relation between the electrode metal workfunction and current-voltage characteristics of the samples can be explained by Fermi level pinning phenomena. Fermi level pinning was already reported for metal and organic semiconductor perylenetetracarboxyl dianhydride (PTCDA) contacts [16]. It can be mentioned, that two groups of I-V characteristics of the samples observed in the present study are close to the cases of the filled and free traps reported in [17] for organic light emitting diode I-V characteristics. In addition it can be noticed, that some authors reported about the bulk limited charge transfer mechanisms such as space charge limited currents in metal/organic semiconductor contacts [18]. However, in most cases contact limited charge transfer mechanisms were revealed: Schottky emission in [19], Fowler-Nordheim tunnelling (emission) in [20, 21], trap activated tunnelling in [17]. Formation of the electrically active traps observed in the present study can be explained by interaction between the organic semiconductor and metal during evaporation of the metal layer. E. g., there were stated in [20], that Au can diffuse into the organic semiconductor as deep as 10 nm.

### 3.3. Charge transfer mechanisms and I-V characteristic hysteresis effects

More detailed analysis of the hysteresis of I-V characteristic measured from –200 V to +200 V and backwards of the metal/organic semiconductor/metal sample is presented in Fig. 13, 14. Cr/E139/Cr sample was choosed for analysis as a typical. It can be seen, that at the first trap activated tunnelling current flow through the sample. Some quasilinear dependence can be seen in Schottky plot in –200 V to –80 V voltages range (Fig. 13, a). However dielectric permittivity calculated from that part of the Schottky plot is unrealistically low (<0.2). I-V characteristic measured “forward” at the positive voltages range can be described by both trap activated tunnelling and Schottky emission currents. Values of the dielectric permittivity calculated from the Schottky plot are ~10 at low voltages, ~3.5 at the medium voltages range and ~5.5 at the highest voltages range. It is within the dielectric permittivities reported for organic semiconductors by other authors range or close to it [13 – 15]. Backward measurement of the I-V characteristic (from +200 V to –200 V) results in the same charge transfer mechanisms as in the case of the measurement from –200 V to +200 V: at the first trap activated tunnelling current is observed. Afterwards charge transfer can be described by mixture of TAT and Schottky emission currents.
Hysteresis in mechanism as well. In the case of the I-V characteristics should be considered as a possible charge transfer at higher voltages (electric field strengths) Schottky emission investigated samples was trap activated tunnelling. At measured.

Hysteresis effect and smallest current densities were organic semiconductor the weakest I-V characteristic organic semiconductor. While in the case of MT-12 observed in the case of the samples fabricated using E-139 strongest hysteresis and largest current densities were characteristic hysteresis effects were observed. The groups. For all the samples mentioned above I-V measurement between the electrode metal workfuntion and I-V voltage characteristics of the all samples fabricated using contacts was observed. There were revealed, that current-measured at the positive voltages activated tunnelling current flow through the sample. Afterwards charge transfer can be described by mixture of TAT and Schottky emission currents. It should be mentioned, that in the case of the Al/AT-RB-2/Al samples I-V characteristics were asymmetrical (diode-like) with big scattering from sample to sample. Therefore its analysis wasn’t done.

CONCLUSIONS

In conclusion I-V characteristics of the metal / organic semiconductor / metal samples were studied. No clear relation between the electrode metal workfuntion and I-V characteristics of the metal / organic semiconductor contacts was observed. There were revealed, that current-voltage characteristics of the all samples fabricated using AT-RB-1, MT-12 and E-139 organic semiconductors and Ti, Al, Cr, Au metal electrodes can be divided into the two groups. For all the samples mentioned above I-V characteristic hysteresis effects were observed. The strongest hysteresis and largest current densities were observed in the case of the samples fabricated using E-139 organic semiconductor. While in the case of MT-12 organic semiconductor the weakest I-V characteristic hysteresis effect and smallest current densities were measured.

The main charge transfer mechanism in the investigated samples was trap activated tunnelling. At higher voltages (electric field strengths) Schottky emission should be considered as a possible charge transfer mechanism as well. In the case of the I-V characteristics hysteresis in ±200 V range there were revealed, that measuring from −200 V to +200 V at the first trap activated tunnelling current flow through the sample. While I-V characteristic measured at the positive voltages range can be described by both trap activated tunnelling and Schottky emission currents. Backward measurement of the I-V characteristic (from +200 V to −200 V) results in the same charge transfer mechanisms as in the case of the measurement from −200 V to +200 V: at the first trap activated tunnelling current is observed. Afterwards charge transfer can be described by mixture of TAT and Schottky emission currents. It should be mentioned, that in the case of the Al/AT-RB-2/Al samples I-V characteristics were asymmetrical (diode-like) with big scattering from sample to sample. Therefore its analysis wasn’t done.

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